## HB526R464DBK Series

1,048,576-word × 64-bit × 4-bank Synchronous Dynamic RAM Module

# HITACHI

### **Description**

The HB526R464DBK is a 1M× 64 × 4 banks Synchronous Dynamic RAM Small Outline Dual In-line Memory Module (S.O.DIMM), mounted 8 pieces of 16-Mbit SDRAM (HM5216805TB) sealed in TCP package and 1 piece of serial EEPROM (24C02) for Presence Detect (PD). An outline of the HB526R464DBK is 144-pin Zig Zag Dual tabs socket type compact and thin package. Therefore, the HB526R464DBK makes high density mounting possible without surface mount technology. The HB526R464DBK provides common data inputs and outputs. Decoupling capacitors are mounted beside each TCP on the module board.

#### **Features**

- 144-pin Zig Zag Dual tabs socket type
  - Outline:  $67.60 \text{ mm (Length)} \times 25.40 \text{ mm (Height)} \times 3.80 \text{ mm (Thickness)}$
  - Lead pitch: 1.27 mm
- 3.3V (±0.3 V) power supply
- Clock frequency: 100 MHz / 83 MHz
- LVTTL interface
- 4 Banks can operates simultaneously and independently
- Burst read/write operation and burst read/single write operation capability
- Programmable burst length: 1/2/4/8/full page
- Programmable burst sequence
  - Sequential/interleave
- Full page burst length capability
  - Sequential burst
  - Burst stop capability
- Programmable  $\overline{CAS}$  latency : 2/3
- 4096 refresh cycles: 64 ms



## **HB526R464DBK Series**

- 2 variations of refresh
  - Auto refresh
  - Self refresh

### **Ordering Information**

Type No.	Frequency	Package	Contact pad
HB526R464DBK-10 HB526R464DBK-12	100 MHz 83 MHz	Small outline DIMM (144-pin)	Gold

Note: The specification of this device is subject to change without notice. Please contact your nearest Hitachi's Sales Dept. regarding specification.

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## HITACHI

#### Hitachi, Ltd.

Semiconductor & IC Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan Tel: Tokyo (03) 3270-2111

Fax: (03) 3270-5109

#### For further information write to:

Hitachi America, Ltd. Semiconductor & IC Div. 2000 Sierra Point Parkway Brisbane, CA. 94005-1835 U S A

Tel: 415-589-8300 Fax: 415-583-4207 Hitachi Europe GmbH Electronic Components Group Continental Europe Dornacher Straße 3 D-85622 Feldkirchen München Tel: 089-9 91 80-0

Tel: 089-9 91 80-0 Fax: 089-9 29 30 00 Hitachi Europe Ltd.
Electronic Components Div.
Northern Europe Headquarters
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA
United Kingdom
Tel: 0628-585000
Fax: 0628-778322

Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 0104 Tel: 535-2100 Fax: 535-1533

Hitachi Asia (Hong Kong) Ltd. Unit 706, North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon Hong Kong

Tel: 27359218 Fax: 27306071